

Trend Paper

Seven considerations for digital over analog

Technology comparison and application considerations

In the past, temperature sensing was primary performed by evaluation of analog sensing components like RTDs, NTCs or thermocouples. New use cases, like IoT (Internet of Things) support the implementation of digital temperature sensors in several industries like industrial controls, consumer devices, or medical instruments and systems. These requirements combine the ease of use with challenging performance and reasonable costs without the need for additional circuitries to bias the sensing components or determine the measured temperature. Additionally, no further calibration or linearization of the sensed signal is required to derive repeatable and reliable results.



Criteria Comparison to Analog Sensors

Digital Temperature Sensing

1 ACCURACY

ANALOG

DIGITAL

The total system accuracy must be considered since the measurement circuitry adds a certain error to the total error budget. Therefore, the stated accuracy of the sensing element is typically

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ANALOG	DIGITAL
Ultra-low to ultra-high temperatures.	The usable temperature range of digital sensors is typically limited to -40°C to +125/+150°C.

POWER CONSUMPTION

TEMPERATURE RANGE

only 50% of the total error budget.

ANALOG	DIGITAL
Circuitries like current sources are used to bias the sensor component leading to a significant power consumption. Additional measurement errors introduced by self-heating also needs to be considered	Power is primarily consumed only when measurements are taken. During power down states, there is minimal power consumption and negligible self-heating.

DATA RELIABILITY

ANALOG	DIGITAL
The contact to the object to be measured and the lead resistance might impact the measurement accuracy and reliability due to degradation. Also, additional noise or drift of the analog to digital conversion are possibilities for erroneous readings.	The received data is either valid or null. Additionally, checksums (error detection algorithms) can be used to validate the memory content as well as the transmitted data itself.

INTEGRATION EFFORT

ANALOG	DIGITAL
External circuitries needed to drive and evaluate the sensing component. Firmware to be developed to determinate the temperature with respect to the measured analog signals.	No additional external components needed except for a microcontroller with simple digital interfaces like I ² C or SPI.

6 SIZE

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Smallest sizes down to <1mm with two wire configurations available.

DIGITAL

Ongoing reduction of silicon die and therefore package sizes. Package dimensions down to 1.5mm x 1.5mm.

ANALOG

The total system costs consist of the sensing element itself accompanied with bias circuitry, quality A/D-converter, etc.

DIGITAL

Digital temperature sensors are competitively priced and have declined in cost over the last few years.



Measurement and Application Considerations

General

To achieve the most accurate temperature measurement results, below are our recommendations:

- Use a stable and noise free supply voltage
- Place a ceramic capacitor close to the supply pins (see datasheet)
- Keep supply lines as short as possible
- Isolate the sensor from any heat source which is not meant to be measured including electronics within the assembly.
- Avoid air streams if the PCB temperature is meant to be measured

Distinguish between objects to be measured



Surrounding Air

Implement thermal isolation from any electronics as well as heat generating objects beside the sensors.

- Add a milled thermal relief
- Reduce PCB-Thickness/Flex-PCB
- Do not connect the DAP (Die Attach Pad) to the copper plain of the PCB



PCB

Connect the DAP (Die Attach Pad) to the copper plain of the PCB.

Self-heating

Self-heating is generated by the current consumed while the temperature measurement is performed. Digital temperature sensors, like TSYS03, limit this effect by low operating and very low stand-by current. Nevertheless, it is recommended to limit the measurement update rate to avoid self-heating and improve the life time for battery driven systems.





Time Constant

The resulting step response is determined by the thermal mass as well as the thermal conductivity of the sensor material as well as the medium the sensor is exposed to. Ongoing reduction of silicon die and therefore package sizes result in lower step responses. Both sensors were tested exposed to an air stream or a non-conductive liquid changing temperature from +25°C to +75°C.





XDF6		TDFN8	
Conditions	Туре	Conditions	Туре
$t_{63} (t_1 > t_2)$ $t_1 = 25^{\circ}C (air Om/s)$ $t_2 = 75^{\circ}C (liquid)$ PCB 900mm ² x 1.5mm FR4	1s	$t_{63} (t_1 > t_2)$ $t_1 = 25^{\circ}C (air Om/s)$ $t_2 = 75^{\circ}C (liquid)$ PCB 900mm ² x 1.5mm FR4	3s
$t_{63} (t_1 > t_2)$ $t_1 = 25^{\circ}C (air 0m/s)$ $t_2 = 75^{\circ}C (air stream 60m/s)$ PCB 900mm ² x 1.5mm FR4	2s	$t_{63} (t_1 > t_2)$ $t_1 = 25^{\circ}C (air Om/s)$ $t_2 = 75^{\circ}C (air stream 60m/s)$ PCB 900mm ² x 1.5mm FR4	4s

Conclusion

Digital temperature sensors are a versatile solution to measure temperature in an accurate, reliable and costeffective way, meeting the demands of several applications and markets.

TE Connectivity (TE) is one of the largest sensor companies worldwide, with innovative sensor solutions that help customers transform concepts into smart, connected creations. Find out more about TE digital temperature sensor portfolio **here**.



About TE Connectivity

TE Connectivity is a \$13 billion global industrial technology leader creating a safer, sustainable, productive, and connected future. Our broad range of connectivity and sensor solutions, proven in the harshest environments, enable advancements in transportation, industrial applications, medical technology, energy, data communications, and the home. With nearly 80,000 employees, including more than 8,000 engineers, working alongside customers in approximately 150 countries, TE ensures that EVERY CONNECTION COUNTS. Learn more at www.te.com

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